

10072353-X01-XXXXF

S = 0.38 μ m GOLD/GXT DN CONTACT AREA
2.0 μ m MIN MATTE TIN DN TAIL

ROHS COMPATIBLE
NOTE 6

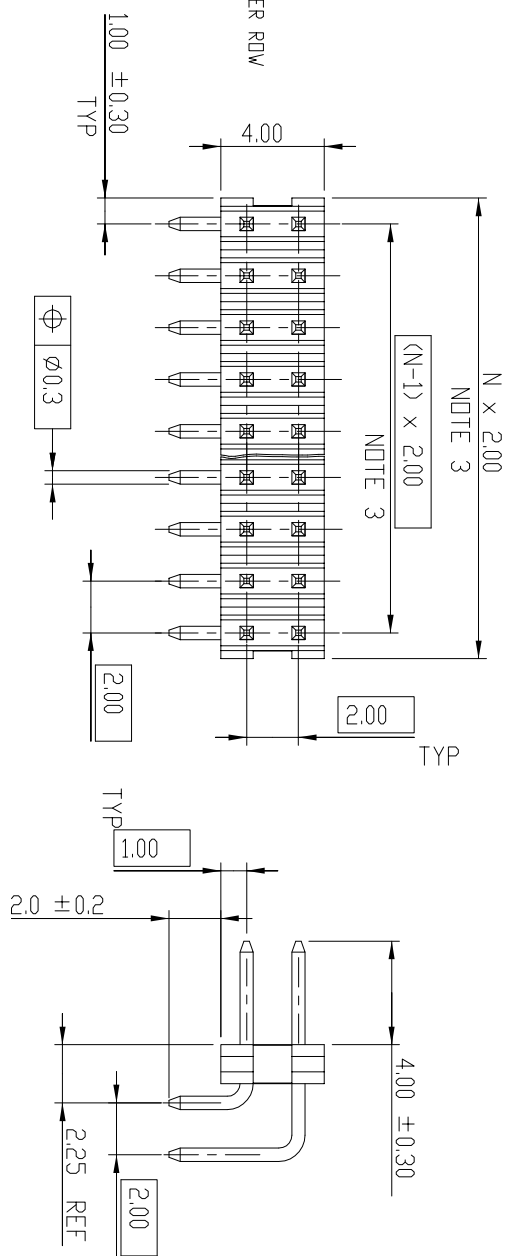
G = 0.76μm GOLD/GXT ON CONTACT AREA
2.0μm MIN MATTE TIN ON TAIL

PACKAGING NOTE 5

F = GOLD FLASH DN CONTACT AREA
2.0µm MIN MATTE TIN DN TAIL

NB OF POSITIONS PER ROW
02 TO 25 PDS

1.27 μm MIN NICKEL UNDERPLATING



1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR BLACK

2. MATERIAL TERMINAL: COPPER ALLOY

3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW.

4. 7N MIN PIN RETENTION IN EITHER DIRECTION.

5. PACKAGING :

= PLASTIC BOX

U = TUBE AVAILABLE FROM 06 TO 50 POS
6. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

α - PLATING

= "LF" MEANS THE PRODUCT IS LEAD-FREE
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 30 SECONDS MAX IN A CONVECTION, INRA-RED DR VAPOR PHASE OR REFLOW OVEN.

C - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920.

d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-47-0004

rev	ech no	dr	date
A	F06-0326	LMU	07.01.04
B	F08-0145	ELA	17.04.08
C	B-19190	LMU	14.10.24
-	-	-	-
-	-	-	-
-	-	-	-
-	-	-	-

www.fciconnect.com		surface - / tolerance std		projection		mm
ISO 1302		ISO 406 ISO 1101				
TOLERANCES UNLESS OTHERWISE SPECIFIED						
Dr	L MULIN	ANGULAR		size		Scale
Eng	J COMPAGNON	LINEAR		A3		
Chn	-	0.0XX ± 0.05		ECN		5:1
Appr	JMC	0.0XX ± 0.05		ECN		-
UNSHR HEADER		Product family		Minitek		Spec ref
title		RIGHT ANGLE PIP		dwg		Rev.
catalog no		-		CUSTOMER Drawing		sheet 1 of 1
FCI		1007/2353		C		

2.00

2.00

NON ACCUMULATIVE

RECOMMENDED 16mm THICK PCB LAYOUT
STENCIL DESIGN RECOMMENDATIONS
AS PER IA-895